

Peltron®

Product Name	XJS-3060-1
Product Category	Conductive Adhesive
Usage	Semiconductor Modules, Car Electro Devices, General Modules, Die Attach, Solar Batterys
Function	One Component, Fast Curing

Item	Condition	Unit	Typical Value
As supplied			
Appearance	visual	—	silver yellow
Binder	—	—	epoxy
Viscosity	Type E Viscometer / 5rpm / 25°C	Pa·s	5~20
Gel Time	145°C (On the heat plate)	sec	8
Storage Stability	Unopen / Frozen at -	—	2 months
As cured			
curing condition	Heat air circulation oven	—	150°C×2 minutes
Volume resistivity	150°C×2 minutes	Ω·cm	5.0×10^{-3}
Die share strength	Si/ Al ₂ O ₃	N/mm ²	35

The above values are typical and not specification



PELNOX, LTD.

Tokyo Sales Office 3-7-2, Nihonbashi-Honcho, Chuo-ku, Tokyo, 103-0023, Japan
TEL : 81-3-5645-3782 FAX : 81-3-5645-3784

R&D Center 8-7, Bodai, Hadano-shi, Kanagawa, 259-1302, Japan
TEL : 81-463-86-8001 FAX : 81-463-86-8022